## PATENTS ABSTRACTS OF JA:\\N

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ILLUMINATION SYSTEM

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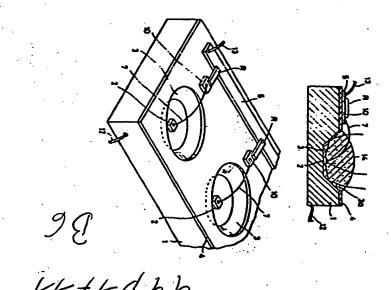
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PURPOSE: and a conductive layer in the recess. substrate, thereby eliminating the necessity of laminating an insulating layer emitting element in an element containing recess to conduct it with a metal To readily manufacture an illuminator by directly arranging a light

CONSTITUTION: A plurality of element containing recesses 3 are formed at recess 3 to conduct with the substrate 1, and electrically connected via gold wirings 7 as leads with the conductive layer 10 of the element conductor chip, directly disposed fixedly at the center on the bottom of each a suitable interval longitudinally on a metal substrate 1 made of a conductive longitudinally of the substrate 1. A light emitting element 2 is made of a semilayer 4. A common conductive layer 5 is so formed∕on the layer 4 as to extend material, and the surface except the recesses 3 is covered with an insulating



EGENDE zu den Bibliographiedaten

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